



Application No. 09/755,282

1FW AF
2821

April 30, 2004

Commissioner for Patents
P.O. Box 1435
Alexandria, VA 22313-1450

FROM: George O. Saile, Reg. No. 19,572
28 Davis Ave.
Poughkeepsie, N.Y. 12603

SUBJECT: Serial #: 09/755,282
File Date: 01/08/01
Inventor: CHEN, SHENG-HSIUNG
Examiner: MITCHELL, JAMES M.
Art Unit: 2827
Title: METHOD OF IMPROVING COPPER PAD ADHESION

RESPONSE TO OFFICE ACTION

This is in response to the office action dated March 10, 2004. Please amend the above identified Divisional Application for patent as follows.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1435, Alexandria, VA 22313-1450 on May 10, 2004.

Signature

Date:

5/10/04

Stephen B. Ackerman, Reg. No. 37,761

Table of Contents:

Amendment to Specifications found on page 3

Amendment and Listing of Claims found on page 4

Remarks found on page 6